IEEE P802.11
Wireless LANs

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| Minutes for TGbe MAC Ad-Hoc teleconferences in July to September 2021  |
| Date: 2021-07-21 |
| Author(s): |
| Name | Affiliation | Address | Phone | email |
| Jeongki Kim | Ofinno |  |  | jeongki.kim.ieee@gmail.com |
| Liwen Chu | NXP |  |  | liwen.chu@nxp.com |
|  |  |  |  |  |

Abstract

This document contains the meeting minutes for the TGbe MAC ad hoc teleconferences in July to September 2021.

Revisions:

* Rev0: Added the minute from the telephone conference held on July 21.
* Rev1: Added the minute from the telephone conference held on July 22.
* Rev2: Added the minute from the telephone conference held on July 26.

**Wendsday 21 July 2021, 10:00 – 12:00pm ET (TGbe MAC ad hoc conference call)**

Chairman: Liwen Chu (NXP)

Secretary: Jeongki Kim (Ofinno)

This meeting took place using a webex session.

**Introduction**

1. The Chair (Liwen, NXP) calls the meeting to order at 10:05am EDT. The Chair introduces himself and the Secretary.
2. The Chair goes through the 802 and 802.11 IPR policy and procedures and asks if there is anyone that is aware of any potentially essential patents.
	1. Nobody responds.
3. The Chair goes through the IEEE copyright policy.
4. The Chair recommends using IMAT for recording the attendance.
	* Please record your attendance during the conference call by using the IMAT system:
		+ 1) login to [imat](https://imat.ieee.org/attendance), 2) select “802.11 Telecons (<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “TGbe <MAC/PHY/Joint> conference call that you are attending.
	* If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Liwen Chu (liwen.chu@nxp.com) and Jeongki Kim (jeongki.kim.ieee@gmail.com)
5. The Chair asked whether there is comment about agenda in 11-21/1090r6. Several changes are made per the comment. The modified agenda was approved.

**Recorded attendance through Imat and e-mail:**

|  |  |  |  |
| --- | --- | --- | --- |
| Breakout | Timestamp | Name | Affiliation |
| TGbe (MAC) | 7/21 | Aboulmagd, Osama | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/21 | Ajami, Abdel Karim | Qualcomm Incorporated |
| TGbe (MAC) | 7/21 | Baek, SunHee | LG ELECTRONICS |
| TGbe (MAC) | 7/21 | Bankov, Dmitry | IITP RAS |
| TGbe (MAC) | 7/21 | Bluschke, Andreas | Signify |
| TGbe (MAC) | 7/21 | Bravo, Daniel | Intel Corporation |
| TGbe (MAC) | 7/21 | Bredewoud, Albert | Broadcom Corporation |
| TGbe (MAC) | 7/21 | CHERIAN, GEORGE | Qualcomm Incorporated |
| TGbe (MAC) | 7/21 | Chitrakar, Rojan | Panasonic Asia Pacific Pte Ltd. |
| TGbe (MAC) | 7/21 | Choi, Jinsoo | LG ELECTRONICS |
| TGbe (MAC) | 7/21 | CHUN, JINYOUNG | LG ELECTRONICS |
| TGbe (MAC) | 7/21 | Coffey, John | Realtek Semiconductor Corp. |
| TGbe (MAC) | 7/21 | Das, Subir | Perspecta Labs Inc |
| TGbe (MAC) | 7/21 | Dong, Xiandong | Xiaomi Inc. |
| TGbe (MAC) | 7/21 | Fang, Yonggang | Mediatek |
| TGbe (MAC) | 7/21 | Galati Giordano, Lorenzo | Nokia |
| TGbe (MAC) | 7/21 | Gu, Xiangxin | Unisoc |
| TGbe (MAC) | 7/21 | Handte, Thomas | Sony Corporation |
| TGbe (MAC) | 7/21 | Ho, Duncan | Qualcomm Incorporated |
| TGbe (MAC) | 7/21 | Hu, Chunyu | Facebook |
| TGbe (MAC) | 7/21 | Huang, Po-Kai | Intel Corporation |
| TGbe (MAC) | 7/21 | Ibrahim, Ahmed | Samsung Research America |
| TGbe (MAC) | 7/21 | Jang, Insun | LG ELECTRONICS |
| TGbe (MAC) | 7/21 | Joh, Hanjin | KT Corp. |
| TGbe (MAC) | 7/21 | Kain, Carl | USDoT; Noblis, Inc. |
| TGbe (MAC) | 7/21 | Kakani, Naveen | Qualcomm Incorporated |
| TGbe (MAC) | 7/21 | Kedem, Oren | MaxLinear |
| TGbe (MAC) | 7/21 | Khorov, Evgeny | IITP RAS |
| TGbe (MAC) | 7/21 | Kim, Jeongki | Ofinno |
| TGbe (MAC) | 7/21 | kim, namyeong | LG ELECTRONICS |
| TGbe (MAC) | 7/21 | Kim, Sang Gook | LG ELECTRONICS |
| TGbe (MAC) | 7/21 | Kim, Sanghyun | WILUS Inc |
| TGbe (MAC) | 7/21 | Kim, Youhan | Qualcomm Incorporated |
| TGbe (MAC) | 7/21 | Kishida, Akira | Nippon Telegraph and Telephone Corporation (NTT) |
| TGbe (MAC) | 7/21 | Klein, Arik | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/21 | Ko, Geonjung | WILUS Inc. |
| TGbe (MAC) | 7/21 | Lalam, Massinissa | SAGEMCOM BROADBAND SAS |
| TGbe (MAC) | 7/21 | Lee, Hong Won | LG ELECTRONICS |
| TGbe (MAC) | 7/21 | Levitsky, Ilya | IITP RAS |
| TGbe (MAC) | 7/21 | Li, Yunbo | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/21 | Lim, Dong Guk | LG ELECTRONICS |
| TGbe (MAC) | 7/21 | lim, taesung | LG ELECTRONICS |
| TGbe (MAC) | 7/21 | Liu, Yong | Apple, Inc. |
| TGbe (MAC) | 7/21 | Lorgeoux, Mikael | Canon Research Centre France |
| TGbe (MAC) | 7/21 | Lou, Hanqing | InterDigital, Inc. |
| TGbe (MAC) | 7/21 | Lu, kaiying | MediaTek Inc. |
| TGbe (MAC) | 7/21 | Lu, Liuming | Guangdong OPPO Mobile Telecommunications Corp.,Ltd |
| TGbe (MAC) | 7/21 | LU, Yuxin | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/21 | Luo, Chaoming | Beijing OPPO telecommunications corp., ltd. |
| TGbe (MAC) | 7/21 | Martinez Vazquez, Marcos | MaxLinear Corp; MAXLINEAR INC |
| TGbe (MAC) | 7/21 | Max, Sebastian | Ericsson AB |
| TGbe (MAC) | 7/21 | McCann, Stephen | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/21 | Montemurro, Michael | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/21 | Naik, Gaurang | Qualcomm Incorporated |
| TGbe (MAC) | 7/21 | NANDAGOPALAN, SAI SHANKAR | Infineon Technologies |
| TGbe (MAC) | 7/21 | Nayak, Peshal | Samsung Research America |
| TGbe (MAC) | 7/21 | Ng, Boon Loong | Samsung Research America |
| TGbe (MAC) | 7/21 | Ouchi, Masatomo | Canon |
| TGbe (MAC) | 7/21 | PANG, KUN | Honor Device Co.,Ltd. |
| TGbe (MAC) | 7/21 | Park, Eunsung | LG ELECTRONICS |
| TGbe (MAC) | 7/21 | Patil, Abhishek | Qualcomm Incorporated |
| TGbe (MAC) | 7/21 | Patwardhan, Gaurav | Hewlett Packard Enterprise |
| TGbe (MAC) | 7/21 | Pushkarna, Rajat | Panasonic Asia Pacific Pte Ltd. |
| TGbe (MAC) | 7/21 | Ratnam, Vishnu | Samsung Research America |
| TGbe (MAC) | 7/21 | Rosdahl, Jon | Qualcomm Technologies, Inc. |
| TGbe (MAC) | 7/21 | Ryu, Kiseon | Ofinno |
| TGbe (MAC) | 7/21 | Shafin, Rubayet | Samsung Research America |
| TGbe (MAC) | 7/21 | Stanley, Dorothy | Hewlett Packard Enterprise |
| TGbe (MAC) | 7/21 | Sun, Bo | ZTE Corporation |
| TGbe (MAC) | 7/21 | Sun, Li-Hsiang | Sony Corporation |
| TGbe (MAC) | 7/21 | Torab Jahromi, Payam | Facebook |
| TGbe (MAC) | 7/21 | Tsodik, Genadiy | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/21 | Verenzuela, Daniel | Sony Corporation |
| TGbe (MAC) | 7/21 | Verma, Lochan | Apple, Inc. |
| TGbe (MAC) | 7/21 | VIGER, Pascal | Canon Research Centre France |
| TGbe (MAC) | 7/21 | Wang, Chao Chun | MediaTek Inc. |
| TGbe (MAC) | 7/21 | Wang, Huizhao | Quantenna Communications, Inc. |
| TGbe (MAC) | 7/21 | Wang, Lei | Futurewei Technologies |
| TGbe (MAC) | 7/21 | Wentink, Menzo | Qualcomm Incorporated |
| TGbe (MAC) | 7/21 | Wu, Changqiang | TP-Link Corporation Limited |
| TGbe (MAC) | 7/21 | Wullert, John | Perspecta Labs |
| TGbe (MAC) | 7/21 | Yang, Jay | Nokia |
| TGbe (MAC) | 7/21 | Yano, Kazuto | Advanced Telecommunications Research Institute International (ATR) |
| TGbe (MAC) | 7/21 | Yee, James | MediaTek Inc. |
| TGbe (MAC) | 7/21 | yi, yongjiang | Spreadtrum Communication USA Inc. |

 **Submissions**

1. [1085r2](https://mentor.ieee.org/802.11/dcn/21/11-21-1085-00-00be-cc36-resolution-for-cids-related-to-ml-element-part-1.docx) Resolution for CIDs related to ML element – Part 1 Gaurang Naik

Summary: The author goes through the CR for ML element.

Discussion:

C: 5743, could you defer this?

A:This is related to basic variant ML element.

C: It does not mention the specific subclause. Maybe we can further check it with laurent.

A: There is a CID related to it. This is not related to that issue.

C: Regarding the non-transmitted ID case, the transmitting Link Info does not reflect it.

A: It makes sense. We may change it to Reporting Info instead of it. Ok, I’ll defer CID 6704.

There are many people in the queue.

1. [1087r2](https://mentor.ieee.org/802.11/dcn/21/11-21-1087-00-00be-cc36-resolution-for-cids-in-clause-35-3-2.docx) Resolution for CIDs in Clause 35.3.2 Gaurang Naik

Discussion:

C: Regarding changing the probe resposne to request, do you change it in all parts? Enough ?

C: Go to ML probe request/response definition.

A: I defered all CIDs related to it.

1. [1172r1](https://mentor.ieee.org/802.11/dcn/21/11-21-1172-00-00be-cc36-resolution-for-cids-related-to-mlo-power-save.docx) Resolution for CIDs related to MLO Power-save Abhishek Patil

Discussion:

C: frame exchange (DL/UL), do we need to change it in whole spec?

A: Ok, any objection to remove DL/UL in the text?

The DL/UL is removed in proposed text.

C: The doze state STA may not receive the Beacon in the diagram.

A: AP sends the Beacon at TBTT regardless of the STA’s power saving state.

C: PM=0, 1 is set by non-AP STA. Those should not be general. Who is originator of PM?

A: Texts already mentioned it. I’m fine. I’ll fix it.

C: You can differentiate it to DL/UL frame in the figure.

A: Ok, I’ll go to Rojan’s suggestion.

C: Regarding MLD max idle period management, you can remove the condition and keep the may.

3 CIDs (7061, 6134, 4387) were defered.

**SP: Do you agree to incorporate the proposed draft text in 11-21/1172r2 to the latest Tgbe Draft to resolve the following comments?**

* 4465, 6210, 6300, 5259, 4466, 5260, 8342, 7725, 6211, 4386, 4467, 6302, 7415, 6301, 7416, 6212, 4067, 4388, 7417, 4114, 6735, 4468, 7419

**No objection.**

**The chair asked whether there is any other business before adjourning the call. Nobody spoke.**

**The meeting was adjourned at 11:55 ET.**

**Thursday 22 July 2021, 10:00 – 12:00pm ET (TGbe MAC ad hoc conference call)**

Chairman: Liwen Chu (NXP)

Secretary: Jeongki Kim (Ofinno)

This meeting took place using a webex session.

**Introduction**

1. The Chair (Liwen, NXP) calls the meeting to order at 10:03am EDT. The Chair introduces himself and the Secretary.
2. The Chair goes through the 802 and 802.11 IPR policy and procedures and asks if there is anyone that is aware of any potentially essential patents.
	1. Nobody responds.
3. The Chair goes through the IEEE copyright policy.
4. The Chair recommends using IMAT for recording the attendance.
	* Please record your attendance during the conference call by using the IMAT system:
		+ 1) login to [imat](https://imat.ieee.org/attendance), 2) select “802.11 Telecons (<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “TGbe <MAC/PHY/Joint> conference call that you are attending.
	* If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Liwen Chu (liwen.chu@nxp.com) and Jeongki Kim (jeongki.kim.ieee@gmail.com)
5. The Chair asked whether there is comment about agenda in 11-21/1090r8. Several changes are made per the comment. The modified agenda was approved.

**Recorded attendance through Imat and e-mail:**

|  |  |  |  |
| --- | --- | --- | --- |
| Breakout | Timestamp | Name | Affiliation |
| TGbe (MAC) | 7/22 | AbidRabbu, Shaima' | Istanbul Medipol University; Vestel |
| TGbe (MAC) | 7/22 | Ajami, Abdel Karim | Qualcomm Incorporated |
| TGbe (MAC) | 7/22 | Asterjadhi, Alfred | Qualcomm Incorporated |
| TGbe (MAC) | 7/22 | Avallone, Stefano | University of Napoli |
| TGbe (MAC) | 7/22 | B, Hari Ram | NXP Semiconductors |
| TGbe (MAC) | 7/22 | Baek, SunHee | LG ELECTRONICS |
| TGbe (MAC) | 7/22 | Bankov, Dmitry | IITP RAS |
| TGbe (MAC) | 7/22 | Barr, David | MaxLinear |
| TGbe (MAC) | 7/22 | Bredewoud, Albert | Broadcom Corporation |
| TGbe (MAC) | 7/22 | CHAN, YEE | Facebook |
| TGbe (MAC) | 7/22 | Chemrov, Kirill | IITP RAS |
| TGbe (MAC) | 7/22 | CHERIAN, GEORGE | Qualcomm Incorporated |
| TGbe (MAC) | 7/22 | Chitrakar, Rojan | Panasonic Asia Pacific Pte Ltd. |
| TGbe (MAC) | 7/22 | Choi, Jinsoo | LG ELECTRONICS |
| TGbe (MAC) | 7/22 | Chu, Liwen | NXP Semiconductors |
| TGbe (MAC) | 7/22 | Chung, Chulho | SAMSUNG |
| TGbe (MAC) | 7/22 | Coffey, John | Realtek Semiconductor Corp. |
| TGbe (MAC) | 7/22 | Das, Subir | Perspecta Labs Inc |
| TGbe (MAC) | 7/22 | Dong, Xiandong | Xiaomi Inc. |
| TGbe (MAC) | 7/22 | Fang, Yonggang | Mediatek |
| TGbe (MAC) | 7/22 | Fischer, Matthew | Broadcom Corporation |
| TGbe (MAC) | 7/22 | Gu, Xiangxin | Unisoc |
| TGbe (MAC) | 7/22 | GUIGNARD, Romain | Canon Research Centre France |
| TGbe (MAC) | 7/22 | Haider, Muhammad Kumail | Facebook |
| TGbe (MAC) | 7/22 | Han, Jonghun | SAMSUNG |
| TGbe (MAC) | 7/22 | Han, Zhiqiang | ZTE Corporation |
| TGbe (MAC) | 7/22 | Ho, Duncan | Qualcomm Incorporated |
| TGbe (MAC) | 7/22 | Hsu, Chien-Fang | MediaTek Inc. |
| TGbe (MAC) | 7/22 | Hu, Chunyu | Facebook |
| TGbe (MAC) | 7/22 | Jang, Insun | LG ELECTRONICS |
| TGbe (MAC) | 7/22 | Kakani, Naveen | Qualcomm Incorporated |
| TGbe (MAC) | 7/22 | Kim, Jeongki | Ofinno |
| TGbe (MAC) | 7/22 | kim, namyeong | LG ELECTRONICS |
| TGbe (MAC) | 7/22 | Kim, Sang Gook | LG ELECTRONICS |
| TGbe (MAC) | 7/22 | Klein, Arik | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/22 | Kneckt, Jarkko | Apple, Inc. |
| TGbe (MAC) | 7/22 | Ko, Geonjung | WILUS Inc. |
| TGbe (MAC) | 7/22 | Lalam, Massinissa | SAGEMCOM BROADBAND SAS |
| TGbe (MAC) | 7/22 | Lee, Nancy | Signify |
| TGbe (MAC) | 7/22 | Levitsky, Ilya | IITP RAS |
| TGbe (MAC) | 7/22 | Li, Yunbo | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/22 | Lin, Zinan | InterDigital, Inc. |
| TGbe (MAC) | 7/22 | Lorgeoux, Mikael | Canon Research Centre France |
| TGbe (MAC) | 7/22 | Lou, Hanqing | InterDigital, Inc. |
| TGbe (MAC) | 7/22 | Lu, kaiying | MediaTek Inc. |
| TGbe (MAC) | 7/22 | Lu, Liuming | Guangdong OPPO Mobile Telecommunications Corp.,Ltd |
| TGbe (MAC) | 7/22 | Lumbatis, Kurt | CommScope, Inc. |
| TGbe (MAC) | 7/22 | Luo, Chaoming | Beijing OPPO telecommunications corp., ltd. |
| TGbe (MAC) | 7/22 | Max, Sebastian | Ericsson AB |
| TGbe (MAC) | 7/22 | McCann, Stephen | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/22 | Montemurro, Michael | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/22 | NANDAGOPALAN, SAI SHANKAR | Infineon Technologies |
| TGbe (MAC) | 7/22 | Nayak, Peshal | Samsung Research America |
| TGbe (MAC) | 7/22 | Ng, Boon Loong | Samsung Research America |
| TGbe (MAC) | 7/22 | Palayur, Saju | Maxlinear Inc |
| TGbe (MAC) | 7/22 | PANG, KUN | Honor Device Co.,Ltd. |
| TGbe (MAC) | 7/22 | Park, Eunsung | LG ELECTRONICS |
| TGbe (MAC) | 7/22 | Patwardhan, Gaurav | Hewlett Packard Enterprise |
| TGbe (MAC) | 7/22 | Pushkarna, Rajat | Panasonic Asia Pacific Pte Ltd. |
| TGbe (MAC) | 7/22 | Ratnam, Vishnu | Samsung Research America |
| TGbe (MAC) | 7/22 | Ryu, Kiseon | Ofinno |
| TGbe (MAC) | 7/22 | Satrasala, Rajeshwari | NXP Semiconductors |
| TGbe (MAC) | 7/22 | Shafin, Rubayet | Samsung Research America |
| TGbe (MAC) | 7/22 | Sun, Bo | ZTE Corporation |
| TGbe (MAC) | 7/22 | Sun, Yanjun | Qualcomm Incorporated |
| TGbe (MAC) | 7/22 | Verenzuela, Daniel | Sony Corporation |
| TGbe (MAC) | 7/22 | VIGER, Pascal | Canon Research Centre France |
| TGbe (MAC) | 7/22 | Wang, Chao Chun | MediaTek Inc. |
| TGbe (MAC) | 7/22 | Wang, Lei | Futurewei Technologies |
| TGbe (MAC) | 7/22 | Wei, Dong | NXP Semiconductors |
| TGbe (MAC) | 7/22 | Wullert, John | Perspecta Labs |
| TGbe (MAC) | 7/22 | Yang, Jay | Nokia |
| TGbe (MAC) | 7/22 | Yano, Kazuto | Advanced Telecommunications Research Institute International (ATR) |
| TGbe (MAC) | 7/22 | Yee, James | MediaTek Inc. |
| TGbe (MAC) | 7/22 | yi, yongjiang | Spreadtrum Communication USA Inc. |
| TGbe (MAC) | 7/22 | Zhou, Pei | Guangdong OPPO Mobile Telecommunications Corp.,Ltd |

 **Submissions**

1. [1211r0](https://mentor.ieee.org/802.11/dcn/21/11-21-1211-00-00be-cc-36-cr-for-ft.docx) CC 36 CR for FT Po-Kai Huang [20’]

Discussion:

C: Basic variant ML element, association frame, beacon, etc. Does it contain all elements or inheritance? Is that described somewhere?

A: I don’t think. Authentication request contains MLD address at least.

C: The baseline text of MLO is slightly different.

A: This is mentioning the managment frame format.

C: 7452 could be included in this document.

C: What about RSN support?

A: This is in the baseline?

1. [1207r0](https://mentor.ieee.org/802.11/dcn/21/11-21-1207-00-00be-cc36-resolution-for-cids-for-35-3-4-1.docx) CC36 resolution for CIDs for 35.3.4.1 Laurent Cariou [25’]

Discussion:

C: the last bullet is not related to the other three bullet. We can keep three bullets.

C: There is arguement on SSID stuff. We should have clear texts whether they are the same or not. How about timestamp, etc.?

A: I can defer this.

1. [1208r3](https://mentor.ieee.org/802.11/dcn/21/11-21-1208-01-00be-cc36-resolution-for-cids-for-35-3-4-2.docx) CC36 resolution for CIDs for 35.3.4.2 Laurent Cariou [25’]

Discussion:

C: Regarding changing affiliated to to affiliated with, you need to check other subclause indicated in the CID 6196.

A: Ok.

1. [228r2](https://mentor.ieee.org/802.11/dcn/21/11-21-0228-02-00be-legacy-addressing-in-mlo.pptx) Legacy Addressing in MLO Rojan Chitrakar [SP-10’]

Discussion:

C: This is just checking the concept of it. Not the motion.

A: Yes. I’m drafting it.

C: The router knows the MLD MAC address?

A: AP MLD knows non-AP MLD MAC address. AP MLD considers non-AP MLD.

228r3

SP1-1:

* **Do you support the following proxy ARP service in R1?**
	+ If an AP MLD supports Proxy ARP service (as described in IEEE 802.11-2020, Clause 11.21.14), then all APs affiliated with the AP MLD shall set the Proxy ARP field to 1 in the Extended Capabilities element.
	+ An AP MLD that supports Proxy ARP service shall implement the requirements defined in Clause 11.21.14 except that when an ARP Request or Neighbor Solicitation message is received by the AP MLD with a target IP address that corresponds to an associated non-AP MLD, the AP MLD shall respond on behalf of the non-AP MLD with an ARP Response or a Neighbor Advertisement message carrying the MLD MAC Address of the non-AP MLD.
* Y/N/A:29/0/41
1. [1938r8](https://mentor.ieee.org/802.11/dcn/20/11-20-1938-08-00be-tb-su-ppdu-and-tb-p2p-ppdu-consideration.pptx) TB SU PPDU and TB P2P PPDU Consideration Jay Yang [SP-10’]
* **SP1: Do you support that 11be defines a mechanism for an AP to allocate one or more portions of its obtained TXOP to multiple associated STAs via a single MU RTS TXS frame under the Triggered TXOP sharing procedure in R2?**

C: One or more portions. Do you mean multiple time portions in TXOPs?

A: Yes.

C: How signal the multiple portions in a single frame?

C: Are you assuming multiple portions using a single frame or each portion per a single frame?

A: I assume a single frame for multiple portions.

C: You need to consider hidden node cases carefully.

A: any suggestion? Removing more?

C: portions is not clear. You mean time portion? How will exactily work for that?

A: Let’s offline discussion.

C: I have submitted the proposal for subchannel selectivity by using MU-RTS/CTS. You try to sharing the frequency resource for multiple devices. For SST devices.

**The chair asked whether there is any other business before adjourning the call. Nobody spoke.**

**The meeting was adjourned at 11:59 ET.**

**Monday 26 July 2021, 19:00 – 21:00pm ET (TGbe MAC ad hoc conference call)**

Chairman: Liwen Chu (NXP)

Secretary: Jeongki Kim (Ofinno)

This meeting took place using a webex session.

**Introduction**

1. The Chair (Liwen, NXP) calls the meeting to order at 19:02am EDT. The Chair introduces himself and the Secretary.
2. The Chair goes through the 802 and 802.11 IPR policy and procedures and asks if there is anyone that is aware of any potentially essential patents.
	1. Nobody responds.
3. The Chair goes through the IEEE copyright policy.
4. The Chair recommends using IMAT for recording the attendance.
	* Please record your attendance during the conference call by using the IMAT system:
		+ 1) login to [imat](https://imat.ieee.org/attendance), 2) select “802.11 Telecons (<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “TGbe <MAC/PHY/Joint> conference call that you are attending.
	* If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Liwen Chu (liwen.chu@nxp.com) and Jeongki Kim (jeongki.kim.ieee@gmail.com)
5. The Chair asked whether there is comment about agenda in 11-21/1090r11. Several changes are made per the comment. The modified agenda was approved.

**Recorded attendance through Imat and e-mail:**

|  |  |  |  |
| --- | --- | --- | --- |
| Breakout | Timestamp | Name | Affiliation |
| TGbe (MAC) | 7/26 | Adachi, Tomoko | TOSHIBA Corporation |
| TGbe (MAC) | 7/26 | Ajami, Abdel Karim | Qualcomm Incorporated |
| TGbe (MAC) | 7/26 | Akhmetov, Dmitry | Intel Corporation |
| TGbe (MAC) | 7/26 | Baek, SunHee | LG ELECTRONICS |
| TGbe (MAC) | 7/26 | Carney, William | Sony Group Corporation |
| TGbe (MAC) | 7/26 | Chitrakar, Rojan | Panasonic Asia Pacific Pte Ltd. |
| TGbe (MAC) | 7/26 | Dong, Xiandong | Xiaomi Inc. |
| TGbe (MAC) | 7/26 | Fang, Yonggang | Mediatek |
| TGbe (MAC) | 7/26 | Fischer, Matthew | Broadcom Corporation |
| TGbe (MAC) | 7/26 | Ghosh, Chittabrata | Facebook, Inc. |
| TGbe (MAC) | 7/26 | Haider, Muhammad Kumail | Facebook |
| TGbe (MAC) | 7/26 | Han, Jonghun | SAMSUNG |
| TGbe (MAC) | 7/26 | Ho, Duncan | Qualcomm Incorporated |
| TGbe (MAC) | 7/26 | Hu, Chunyu | Facebook |
| TGbe (MAC) | 7/26 | Huang, Po-Kai | Intel Corporation |
| TGbe (MAC) | 7/26 | Kain, Carl | USDoT; Noblis, Inc. |
| TGbe (MAC) | 7/26 | Kim, Jeongki | Ofinno |
| TGbe (MAC) | 7/26 | Kim, Sang Gook | LG ELECTRONICS |
| TGbe (MAC) | 7/26 | Kishida, Akira | Nippon Telegraph and Telephone Corporation (NTT) |
| TGbe (MAC) | 7/26 | Klein, Arik | Huawei Technologies Co., Ltd |
| TGbe (MAC) | 7/26 | Ko, Geonjung | WILUS Inc. |
| TGbe (MAC) | 7/26 | Lee, Nancy | Signify |
| TGbe (MAC) | 7/26 | Lou, Hanqing | InterDigital, Inc. |
| TGbe (MAC) | 7/26 | Lu, kaiying | MediaTek Inc. |
| TGbe (MAC) | 7/26 | Lu, Liuming | Guangdong OPPO Mobile Telecommunications Corp.,Ltd |
| TGbe (MAC) | 7/26 | Luo, Chaoming | Beijing OPPO telecommunications corp., ltd. |
| TGbe (MAC) | 7/26 | Naik, Gaurang | Qualcomm Incorporated |
| TGbe (MAC) | 7/26 | NANDAGOPALAN, SAI SHANKAR | Infineon Technologies |
| TGbe (MAC) | 7/26 | Nayak, Peshal | Samsung Research America |
| TGbe (MAC) | 7/26 | Ouchi, Masatomo | Canon |
| TGbe (MAC) | 7/26 | PANG, KUN | Honor Device Co.,Ltd. |
| TGbe (MAC) | 7/26 | Patil, Abhishek | Qualcomm Incorporated |
| TGbe (MAC) | 7/26 | Patwardhan, Gaurav | Hewlett Packard Enterprise |
| TGbe (MAC) | 7/26 | Petrick, Albert | InterDigital, Inc. |
| TGbe (MAC) | 7/26 | Pushkarna, Rajat | Panasonic Asia Pacific Pte Ltd. |
| TGbe (MAC) | 7/26 | Raissinia, Alireza | Qualcomm Incorporated |
| TGbe (MAC) | 7/26 | Ratnam, Vishnu | Samsung Research America |
| TGbe (MAC) | 7/26 | Rosdahl, Jon | Qualcomm Technologies, Inc. |
| TGbe (MAC) | 7/26 | Rubayet Shafin | Samsung Research America |
| TGbe (MAC) | 7/26 | Ryu, Kiseon | Ofinno |
| TGbe (MAC) | 7/26 | Sun, Li-Hsiang | Sony Corporation |
| TGbe (MAC) | 7/26 | Tanaka, Yusuke | Sony Group Corporation |
| TGbe (MAC) | 7/26 | Thompson, Tom | IEEE STAFF |
| TGbe (MAC) | 7/26 | VIGER, Pascal | Canon Research Centre France |
| TGbe (MAC) | 7/26 | Wang, Chao Chun | MediaTek Inc. |
| TGbe (MAC) | 7/26 | Wang, Lei | Futurewei Technologies |
| TGbe (MAC) | 7/26 | Wang, Sean | Shanghai Longsailing Semiconductor Co. Ltd. |
| TGbe (MAC) | 7/26 | Wullert, John | Perspecta Labs |
| TGbe (MAC) | 7/26 | Yang, Jay | Nokia |
| TGbe (MAC) | 7/26 | Yano, Kazuto | Advanced Telecommunications Research Institute International (ATR) |
| TGbe (MAC) | 7/26 | Yee, James | MediaTek Inc. |

 **Submissions**

1. [**1085r**](https://mentor.ieee.org/802.11/dcn/21/11-21-1085-02-00be-cc36-resolution-for-cids-related-to-ml-element-part-1.docx)**3 Resolution for CIDs related to ML element – Part 1 Gaurang Naik [SP-53C 10’]**

**Discussion:**

C: NSTR Indication bitmap, this table is describing the length of the bitmap. It’s complex. Why do yo combine this with the complete profile subfiled? We can discuss it to make it simpler. There is one CID to be discussed. I’m considering it as well.

A: I did not make any technical change of each subfield (e.g., the complete profile subfield).

C: There are tagged #1, #2, #3. It makes confusing. Remove them.

A: Ok, I can do it.

1. [**1087r**](https://mentor.ieee.org/802.11/dcn/21/11-21-1087-03-00be-cc36-resolution-for-cids-in-clause-35-3-2.docx)**4 Resolution for CIDs in Clause 35.3.2 Gaurang Naik [SP-53C 10’]**

**Discussion:**

C: regarding what you remove the shall, why? Is in 35? Then it’s ok

C: Regarding the basic variant probe response. Those are defered?

A: Yes

C: 8225, this inheritance is to reduce the frame body. There is another thing for this. We should replace this with the baseline.

A: Ok, I will defer the CID 8225.

C: This text is already in the spec.

C: 4249, the STA shall include all elements. Why you include all element?

A: This is complete profile.

C: I understand. What is the meaning of all?

A: all that constitute the partial profile.

C: Confusing. Can you remove all in the text?

A: If you have concerns on only all, I’m fine with removing all because it can also resolve it.

**SP: Do you agree to the resolutions provided in doc 11-21/1087r5 for the following CIDs for inclusion in the latest 11be draft?**7715, 6864, 7716, 7365, 5736, 5738, 5737, 4246, 7717, 5390, 4108, 4361, 5600, 5801, 5913, 6221, 6566, 6870, 8223, 8330, 7805, 5391, 4035, 6567, 4377, 6534, 7811, 7847, 8224, 5045, 5601, 6222, 6395, 6872, 7059, 7718, 6568, 4362, 5250, 5966, 7514, 6570, 6396, 6569, 5046, 6878, 5047, 7395, 5739, 6397, 4249

No objection.

1. [**1172r3**](https://mentor.ieee.org/802.11/dcn/21/11-21-1172-03-00be-cc36-resolution-for-cids-related-to-mlo-power-save.docx) **Resolution for CIDs related to MLO Power-save Abhishek Patil [SP-2C 5’]**

**SP: Do you agree to the resolutions provided in doc 11-21/1172r3 for the following CIDs for inclusion in the latest 11be draft?**6134, 4387

No objection

1. [**1175r2**](https://mentor.ieee.org/802.11/dcn/21/11-21-1175-01-00be-cc36-resolution-for-cids-related-to-ml-advertisement-part-1.docx) **Res. for CIDs related to ML advertisement - Part 1 Abhishek Patil [6C 20’]**

C: I agree with the common info length subfield. Do we need the text related to it?

A: there is the similar of RNR element in baseline. This is for the forward compatibility.

C: Length value include the length of STA Info length. Why not adding it to last?

A: It’s whole length.

C: Regarding the Ming’s comment, I prefer the may than is expected to.

**SP: Do you agree to the resolutions provided in doc 11-21/1175r3 for the following CIDs for inclusion in the latest 11be draft?**5043, 4013, 4015, 5044,

No objection

1. [**1203r0**](https://mentor.ieee.org/802.11/dcn/21/11-21-1203-00-00be-cc36-cr-35-3-15-4-capability-signaling.docx) **CC36 CR 35.3.15.4 Capability Signaling Yunbo Li [36C 30’]**

C: I just mention the multi-radio MLD. In the resolution, the indicated subclause mentions only multi-radio non-AP MLD not multi-radio MLD. Can you change it in the resolution?

**The chair asked whether there is any other business before adjourning the call. Nobody spoke.**

**The meeting was adjourned at 21:00 ET.**